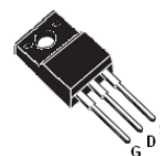


700V N-Channel Super Junction power MOSFET

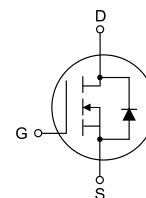
DESCRIPTION

SJ MOSFET is an advanced technology for high voltage power MOSFETs, designed according to the super junction principle by P&S. The offered devices provide all benefits of a fast switching and low on resistance, making it especially suitable for applications which require more efficient, more compact, LED Lighting, High Performance Adapter etc..

V_{DS}	700	V
$R_{DS(ON)}$	400	m Ω
I_D	15	A



TO-220F



Features

- Extremely low losses due to very low $R_{dson} * Q_g$
- Superior Avalanche Rugged Technology
- Fast switching capability
- 100% Avalanche Tested
- Pb-free lead plating; ROHS compliant

APPLICATIONS

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- High Performance Adapter
- LED Lighting Power

ORDERING INFORMATION

Temperature Range	Package		Orderable Device	Package Qty.
-55°C ~ +125°C	TO-220F	Pb-Free	CWS15N70AF	50 PCS/Tube



ABSOLUTE MAXIMUM RATINGS

($T_j=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage ($V_{GS}=0\text{V}$)	V_{DSS}	700	V
Gate-Source Voltage ($V_{DS}=0\text{V}$, static)	V_{GS}	± 30	V
Continuous Drain Current ($T_C=25^{\circ}\text{C}$)(Note 1)	$I_{D(DC)}$	15	A
Continuous Drain Current ($T_C=100^{\circ}\text{C}$) (Note 1)	$I_{D(DC)}$	10	A
Pulsed Drain Current (Note 2)	I_{DM}	45	A
MOSFET dv/dt ruggedness, $V_{DS}\leq 480\text{V}$	dv/dt	50	V/nS
Single Pulsed Avalanche Energy (Note 3)	E_{AS}	400	mJ
Avalanche Energy, Repetitive (Note 1)	E_{AR}	0.7	mJ
Avalanche Current, Repetitive (Note 1)	I_{AR}	7.5	A
Maximum Power Dissipation ($T_C=25^{\circ}\text{C}$)	P_D	33	W
Operating, Storage Temperature Range	T_J, T_{STG}	-55~150	$^{\circ}\text{C}$

THERMAL CHARACTERISTICS

Parameter	Symbol	Min.	Typ.	Max.	Units
Thermal Resistance, Junction-to-Case	R_{thJC}	-	-	3.8	$^{\circ}\text{C/W}$
Thermal Resistance, Junction-to-Ambient	R_{thJA}	-	-	80	$^{\circ}\text{C/W}$

ELECTRICAL CHARACTERISTICS

($T_j = 25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	TYP.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	700	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=700\text{V}, V_{GS}=0\text{V}$	-	-	1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 30\text{V}, V_{DS}=0\text{V}$	-	-	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.5	3.0	3.5	V
Drain-Source On-state Resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}, I_D=7.5\text{A}$	-	0.32	0.4	Ω
Gate Resistance	R_g	F=1MHZ, open drain	-	10.3	-	Ω



Dynamic Characteristics

($T_j = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input capacitance	C_{iss}	$V_{DS}=100\text{V}, V_{GS}=0\text{V},$ $f=1\text{MHz}$	-	1036	-	pF
Output capacitance	C_{oss}		-	44.2	-	
Reverse transfer capacitance	C_{rss}		-	2.16	-	
Turn-on delay Time	$t_{d(on)}$	$V_{DD}=480\text{V}, I_D=15\text{A}$ $R_G=6.8\Omega, V_{GS}=10\text{V}$	-	26	-	ns
Rise time	t_r		-	34		
Turn-off delay time	$t_{d(off)}$		-	109		
Fall time	t_f		-	36		

Gate charge characteristics

($T_j = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Gate to Source Charge	Q_{gs}	$V_{DD}=480\text{V}, I_D=15\text{A}$ $V_{GS}=0$ to 10V	-	5.0	-	nC
Gate to Drain Charge	Q_{gd}		-	8.4	-	
Gate Charge Total	Q_g		-	24	-	
Gate Plateau Voltage	$V_{plateau}$		-	4.4	-	V

Reverse diode characteristics

($T_j = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Body Diode Forward Voltage	V_{SD}	$V_{GS}=0\text{V}, I_{SD}=15\text{A}$	-	0.9	-	V
Reverse Recovery Time	t_{rr}	$V_R=480\text{V}, I_F=15\text{A}$ $di_F/dt=100\text{A}/\mu\text{s}$	-	270	-	nS
Reverse Recovery Charge	Q_{rr}		-	4.1	-	μC
Peak Reverse Recovery Current	I_{rrm}		-	22.8	-	A

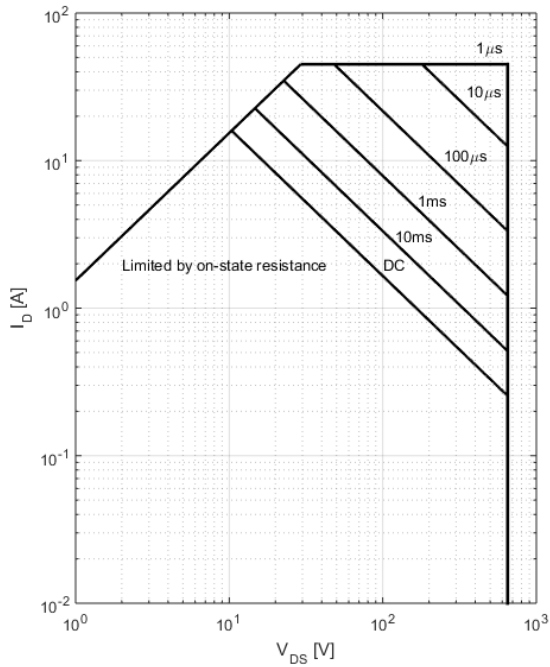
Notes:

1. Limited by maximum junction temperature;
2. Pulse width limited by maximum junction temperature;
3. $I_{AS} = 9\text{ A}$, $V_{DD} = 50\text{ V}$, $R_G = 25\ \Omega$, Starting $T_j = 25^\circ\text{C}$.



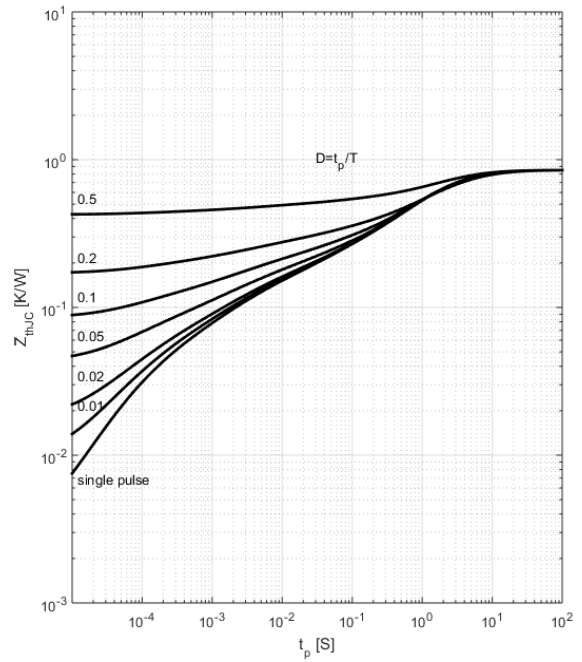
ELECTRICAL CHARACTERISTICS DIAGRAMS

Figure 1. Safe operating area



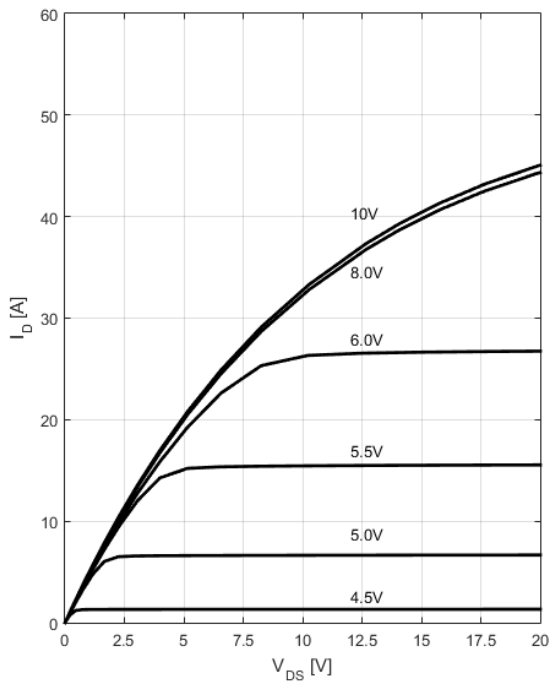
$I_D = f(V_{DS}); T_c = 25^\circ\text{C}; \text{parameter } t_p$

Figure 2. Transient thermal impedance



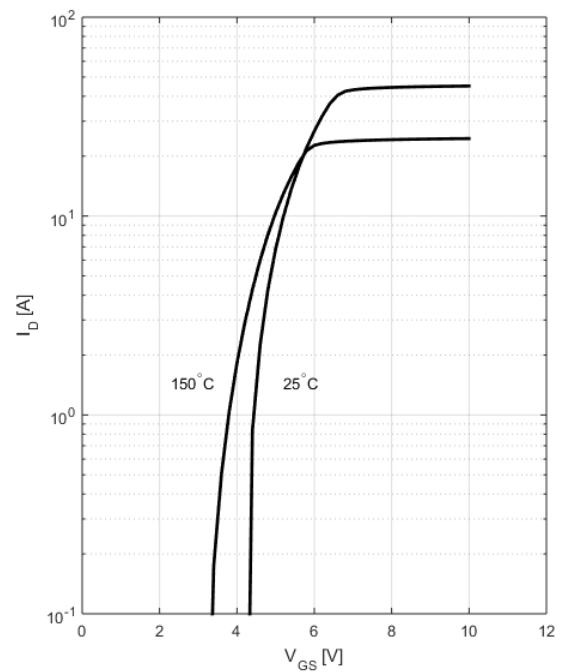
$Z_{(thJC)} = f(t_p); \text{parameter: } D = t_p / T$

Figure 3. Typ. output characteristics



$I_D = f(V_{DS}); T_j = 25^\circ\text{C}; \text{parameter: } V_{GS}$

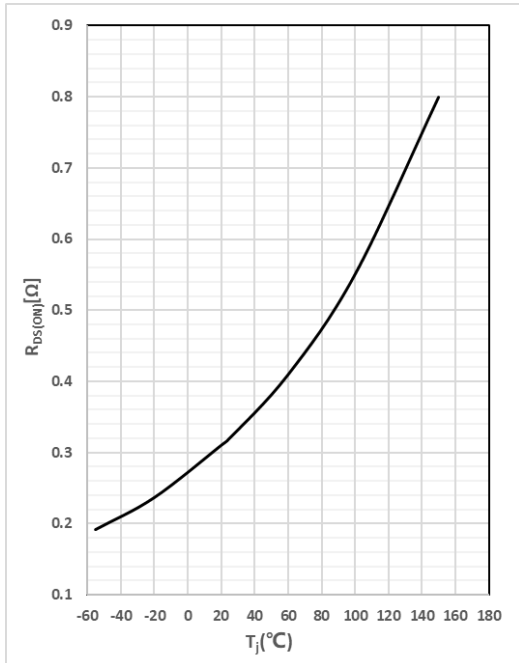
Figure 4. Typ. transfer characteristics



$I_D = f(V_{GS}); V_{DS} = 20\text{V}$

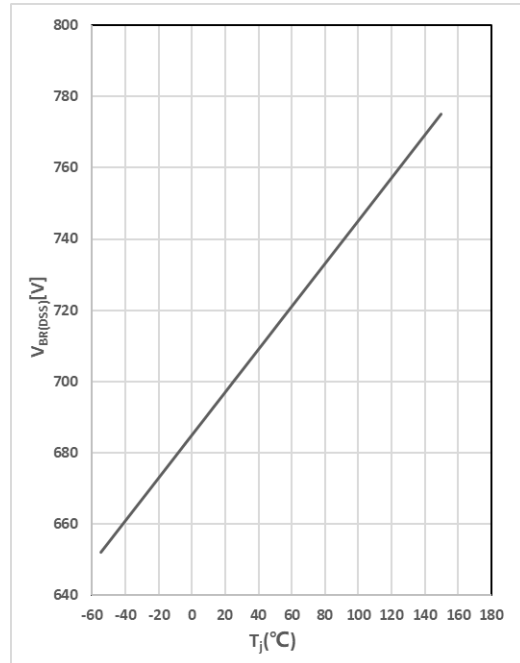


Figure 5. Drain-source on-state resistance



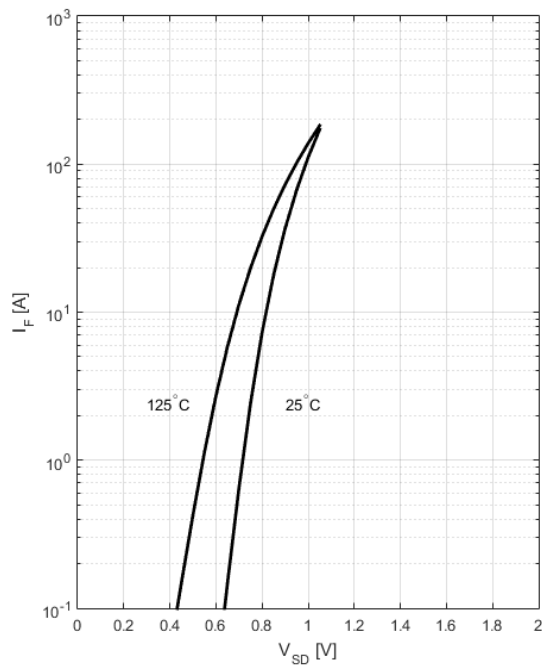
$$R_{DS(ON)}=f(T_j); I_D=15A; V_{GS}=10V$$

Figure6. Drain-source breakdown voltage



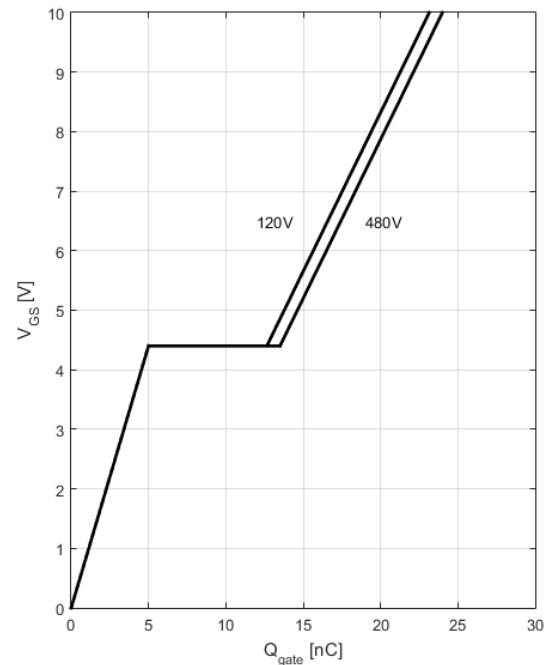
$$V_{BR(DSS)}=f(T_j); I_D=10mA$$

Figure7. Forward characteristics of reverse diode



$$I_F=f(V_{SD}); \text{parameter: } T_j$$

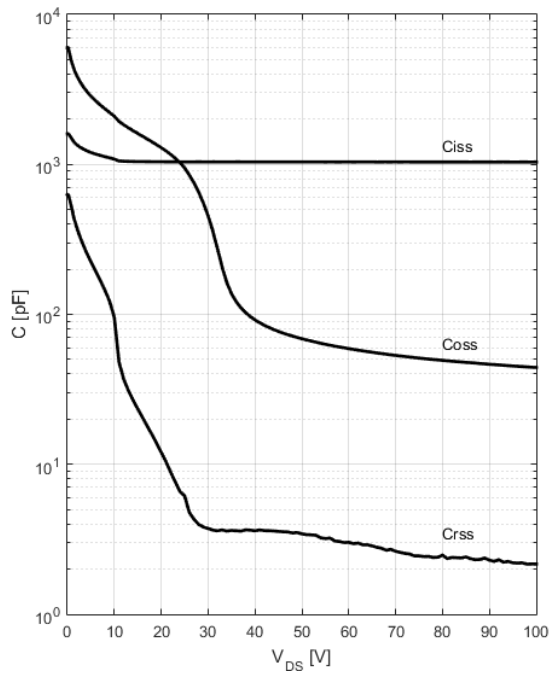
Figure 8. Typ. gate charge



$$V_{GS}=f(Q_{gate}), I_D=15A \text{ pulsed}$$

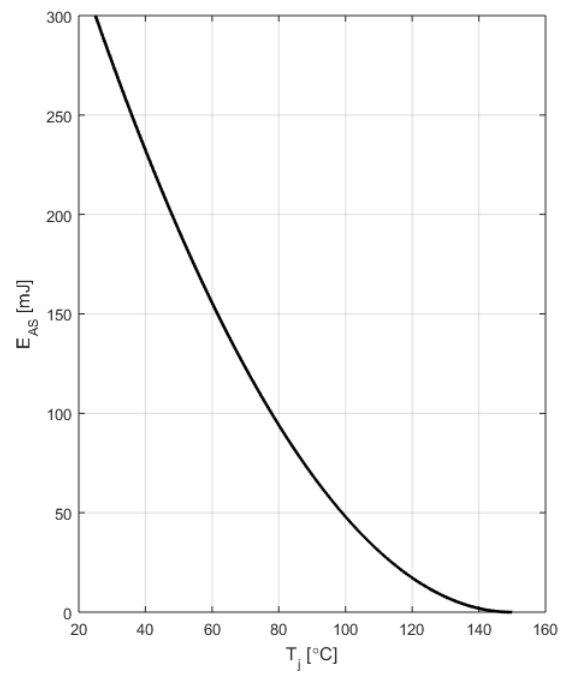


Figure 9: Typ. capacitances



$C=f(V_{DS}); V_{GS}=0; f=1\text{MHz}$

Figure 10: Avalanche energy

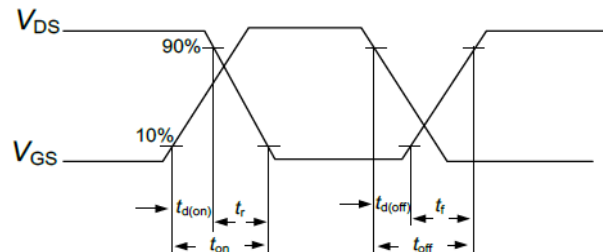
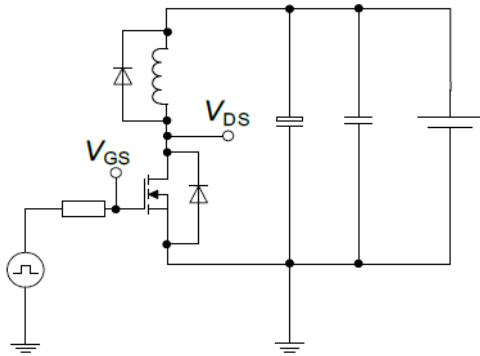


$E_{AS}=f(T_j); I_D=7.5\text{A}; V_{DD}=50\text{V}$

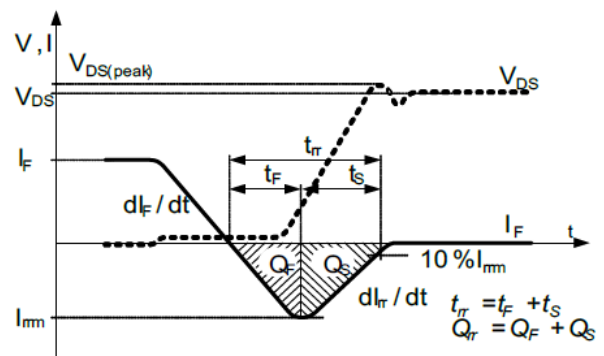
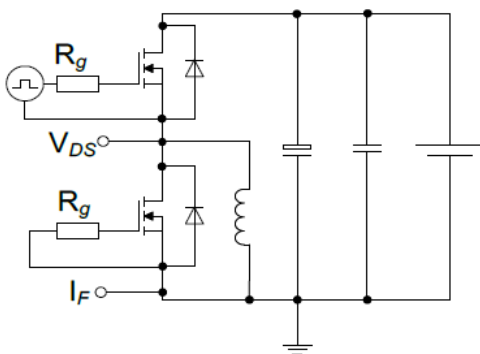


Test Circuits

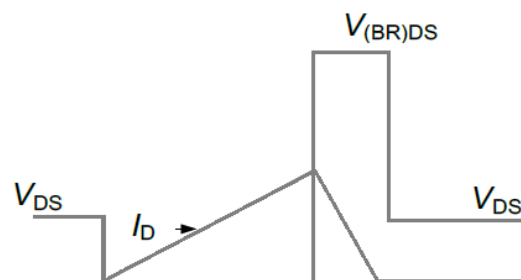
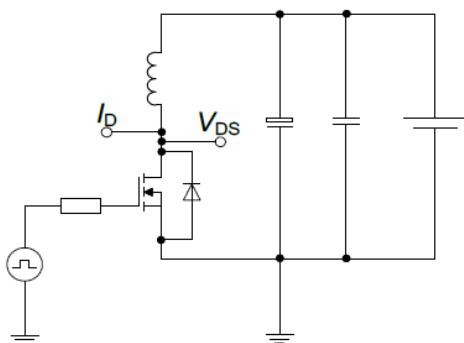
Switch time test circuit



Reverse diode characteristics test circuit and waveform

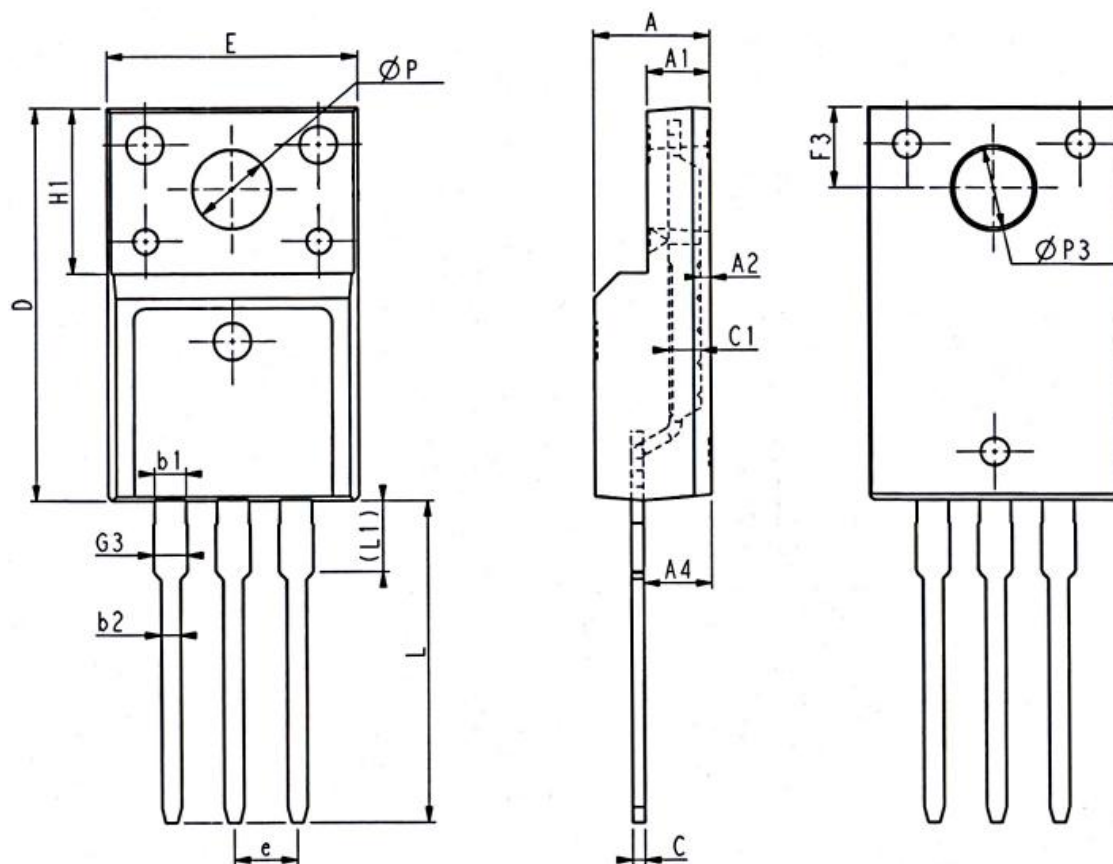


Unclamped inductive switching test circuit & waveform



PHYSICAL DIMENSIONS

TO-220F



Symbol	Dimension (mm)			Symbol	Dimension (mm)		
	Min	Nom	Max		Min	Nom	Max
E	9.96	10.16	10.36	e	2.54(BSC)		
A	4.50	4.70	4.90	L	12.68	12.98	13.28
A1	2.34	2.54	2.74	L1	2.93	3.03	3.13
A2	0.30	0.45	0.60	ØP	3.03	3.18	3.38
A4	2.56	2.76	2.96	ØP3	3.15	3.45	3.65
c	0.40	0.50	0.65	F3	3.15	3.30	3.45
c1	1.20	1.30	1.35	G3	1.25	1.35	1.55
D	15.57	15.87	16.17	b1	1.18	1.28	1.43
H1	6.70(REF)			b2	0.70	0.80	0.95

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